

Value

Unit



Low-Profile Molded Inductor 1.0µH

APPLICATIONS



- Battery-powered devices
- High switching frequency SMPS
- IoT
- Wearable
- Portable devices
- Input filters

FEATURES

- Size 2.0mmx1.6mmx1.0mm
- Low Profile
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Low DCR
- Max Operating Temp +125°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS	
Parameter	

Inductance (1)	L	±20%	1.0	μΗ
Resistance	R _{DC}	typ	50	mΩ
Resistance MAX	R DC MAX	max	60	mΩ
Rated Current (2)	I _R	typ	3.2	Α
Saturation Current 25°C (3)	ISAT 25°C	typ	4.2	Α
Saturation Current 100°C (4)	ISAT 100°C	typ	4.2	Α
Resonance Frequency	fr	typ	84	MHz

GENERAL SPECIFICATIONS

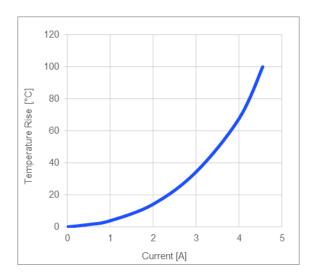
Measured at 100kHz, 100mA
Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
Saturation current will cause L to drop from 30% at 25°C ambient temperature
Saturation current will cause L to drop from 30% at 100°C ambient temperature
Electrical specifications measured at 25°C, 35% RH if not given differently
Operating temperature: -40°C to +125°C (including temp rise)
Should not exceed +125°C under worst-case operation conditions
Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance. "MPS", the MPS logo, and "Simple, Easy Solutions" are registered trademarks of Monolithic Power Systems, Inc. or its subsidiaries.

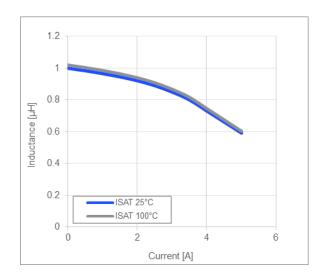


TYPICAL PERFORMANCE CURVES

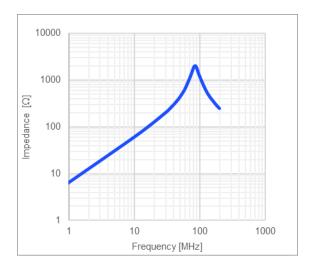
Temperature Rise vs. Current



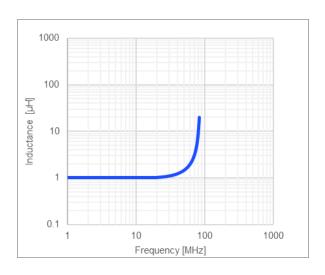
Inductance vs. Current



Impedance vs. Frequency

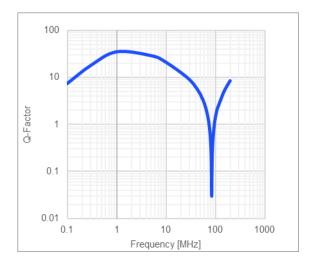


Inductance vs. Frequency

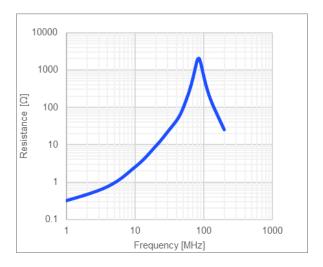




Quality Factor vs. Frequency

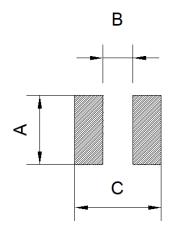


AC Resistance vs. Frequency





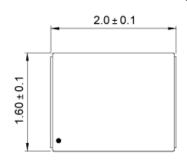
LAND PATTERN		
Dime	ensions	
Α	1.60 ref.	
В	0.70 ref.	
С	2.0 ref.	
	(unit in mm)	

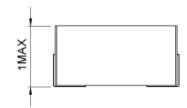


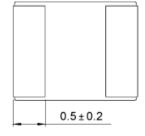
PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)







TOP MARKING

Marki	ing
Start of Winding	· (dot)





ORDERING INFORMATION					
Part Number	L (1)	RDC	I _R ⁽²⁾	I _{SAT 25°C} (3)	I _{SAT 100°C} (4)
T dit Number	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AT2010-R47	0.47	27	4.4	5.7	5.7
MPL-AT2010-R68	0.68	41	3.5	4.9	4.9
MPL-AT2010-1R0	1.0	50	3.2	4.2	4.2
MPL-AT2010-1R5	1.5	97	2.4	3.2	3.2
MPL-AT2010-2R2	2.2	137	2.2	2.7	2.7
MPL-AT2010-4R7	4.7	215	1.5	1.9	1.9

GENERAL SPECIFICATIONS		
(1) Inductance	Measured at 100kHz, 100mA	
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.	
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature	
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature	
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently	
Operating Condition	Operating temperature: -40°C to +125°C (including temp rise) Should not exceed +125°C under worst-case operation conditions	
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH	

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